

NC7S08

TinyLogic® HS 2-Input AND Gate

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ Pb-Free leadless package
- High Speed; t_{PD} 3.5ns typ
- Low Quiescent Power; I_{CC} < 1µA
- Balanced Output Drive; 2mA I_{OL}, –2mA I_{OH}
- Broad V_{CC} Operating Range; 2V–6V
- Balanced Propagation Delays
- Specified for 3V operation

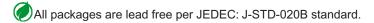
General Description

The NC7S08 is a single 2-Input high performance CMOS AND Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad V_{CC} range. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. Three stages of gain between inputs and outputs assures high noise immunity and reduced sensitivity to input edge rate.

Ordering Information

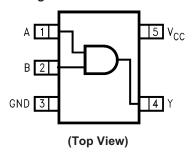
Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7S08M5X	MA05B	7S08	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7S08P5X	MAA05A	S08	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7S08L6X	MAC06A	PP	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

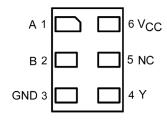


Connection Diagram

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Thru View)

Logic Symbol



Function Table

$$Y = AB$$

Inp	Output			
Α	A B			
L	L	L		
L	Н	L		
Н	L	L		
Н	Н	Н		

H = HIGH Logic Level

L = LOW Logic Level

Pin Description

Pin Names	Description
A, B	Inputs
Υ	Output
NC	No Connect

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +7.0V
I _{IK}	DC Input Diode Current	
	$@V_{IN} \le -0.5V$	–20mA
	@ $V_{IN} \ge V_{CC} + 0.5V$	+20mA
V _{IN}	DC Input Voltage	–0.5V to V _{CC} +0.5V
I _{OK}	DC Output Diode Current	
	@ V _{OUT} < -0.5V	–20mA
	$@V_{OUT} > V_{CC} + 0.5V$	+20mA
V _{OUT}	DC Output Voltage	-0.5V to V _{CC} + 0.5V
I _{OUT}	DC Output Sourceor Sink Current	±12.5mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current per Output Pin	±25mA
T _{STG}	Storage Temperature	–65°C to +150°C
TJ	Junction Temperature	150°C
T _L	Lead Temperature (Soldering, 10 seconds)	260°C
P _D	Power Dissipation @ +85°C	
	SOT23-5	200mW
	SC70-5	150mW

Recommended Operating Conditions⁽¹⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	2.0V to 6.0V
V _{IN}	Input Voltage	0V to V _{CC}
V _{OUT}	Output Voltage	0V to V _{CC}
T _A	Operating Temperature	–40°C to +85°C
t _r , t _f	Input Rise and Fall Time V _{CC} @ 2.0V V _{CC} @ 3.0V V _{CC} @ 4.5V V _{CC} @ 6.0V	Ons to 1000ns Ons to 750ns Ons to 500ns Ons to 400ns
θ_{JA}	Thermal Resistance SOT23-5 SC70-5	300°C/W 425°C/W

Notes:

1. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

				T _A = +25°C			T _A = -		
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
V _{IH}	HIGH Level Input	2.0		1.50			1.50		V
	Voltage	3.0-6.0		0.7 x V _{CC}			0.7 x V _{CC}		
V _{IL}	LOW Level Input	2.0				0.50		0.50	V
	Voltage	3.0-6.0				0.3 x V _{CC}		0.3 x V _{CC}	
V _{OH}	HIGH Level Output	2.0	$I_{OH} = -20\mu A$,	1.90	2.0		1.90		V
	Voltage	3.0	$V_{IN} = V_{IH}$	2.90	3.0		2.90		
		4.5		4.40	4.5		4.40		
		6.0		5.90	6.0		5.90		
		3.0	$V_{IN} = V_{IH},$ $I_{OH} = -1.3 \text{mA}$	2.68	2.85		2.63		
		4.5	$V_{IN} = V_{IH},$ $I_{OH} = -2mA$	4.18	4.35		4.13		
		6.0	$V_{IN} = V_{IH}$, $I_{OH} = -2.6$ mA	5.68	5.85		5.63		
V _{OL}	LOW Level Output	2.0	$I_{OL} = 20\mu A$		0.0	0.10		0.10	V
	Voltage	3.0	$V_{IN} = V_{IL}$		0.0	0.10		0.10	1
		4.5			0.0	0.10		0.10	
		6.0			0.0	0.10		0.10	
		3.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $I_{OH} = 1.3\text{mA}$		0.1	0.26		0.33	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $I_{OL} = 2mA$		0.1	0.26		0.33	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $I_{OL} = 2.6 \text{mA}$		0.1	0.26		0.33	
I _{IN}	Input Leakage Current	6.0	$V_{IN} = V_{CC}$, GND			±0.1		±1.0	μA
I _{CC}	Quiescent Supply Current	6.0	$V_{IN} = V_{CC}$, GND			1.0		10.0	μA

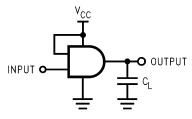
AC Electrical Characteristics

				T,	T _A = +25°C		T _A = -40°C to +85°C			Figure
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Number
t _{PLH} , t _{PHL}	Propagation Delay	5.0	C _L = 15pF		3.5	15			ns	Figure 1
		2.0	C _L = 50pF		20	100		125		Figure 3
		3.0			11	27		35		
		4.5			8	20		25		
		6.0			7	17		21		
t _{TLH} , t _{THL}	Output Transition	5.0	C _L = 15pF		3.0	10			ns	Figure 1
	Time	2.0	C _L = 50pF		25	125		155		Figure 3
		3.0			16	35		45		
		4.5			11	25		31		
		6.0			9	21		26		
C _{IN}	Input Capacitance	Open			2	10		10	pF	
C _{PD}	Power Dissipation Capacitance	5.0	(2)		6				pF	Figure 2

Note:

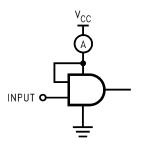
2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



 $\rm C_L$ includes load and stray capacitance Input PRR = 1.0 MHz; $\rm t_W = 500~ns$

Figure 1. AC Test Circuit



Input = AC Waveform;

PRR = variable; Duty Cycle = 50%

Figure 2. I_{CCD} Test Circuit

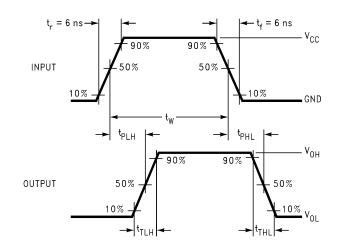


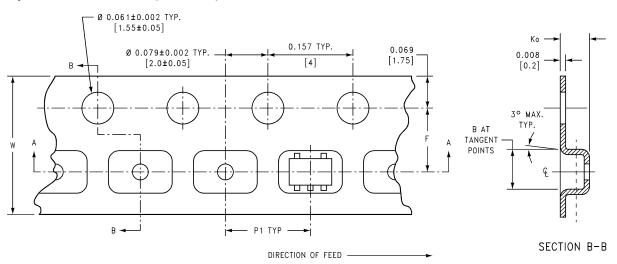
Figure 3. AC Waveforms

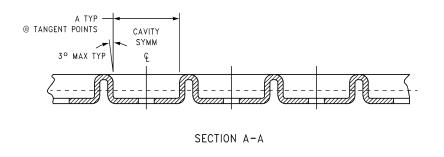
Tape and Reel Specifications

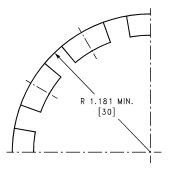
Tape Format for SC70 and SOT23

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
M5X, P5X	Leader (Start End)	125 (typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ.)	Empty	Sealed

Tape Dimensions inches (millimeters)







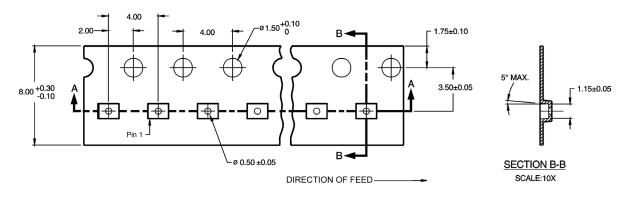
BEND RADIUS NOT TO SCALE

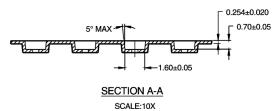
Package	Tape Size	Dim A	Dim B	Dim F	Dim K _o	Dim P1	Dim W
SC70-5	8mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)
SOT23-5	8mm	0.130 (3.3)	0.130 (3.3)	0.138 ± 0.002 (3.5 ± 0.05)	0.055 ± 0.004 (1.4 ± 0.11)	0.157 (4)	0.315 ± 0.012 (8 ± 0.3)

Tape and Reel Specifications (Continued)

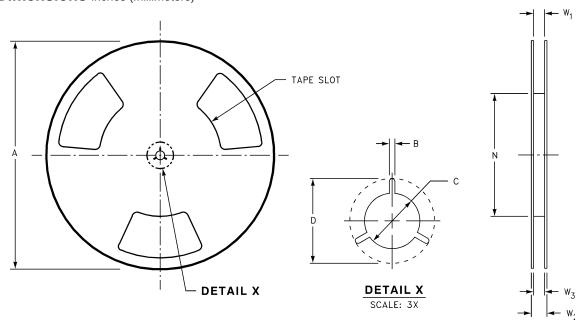
Tape Format for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status	
L6X	Leader (Start End)	125 (typ.)	Empty	Sealed	
	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (typ.)	Empty	Sealed	



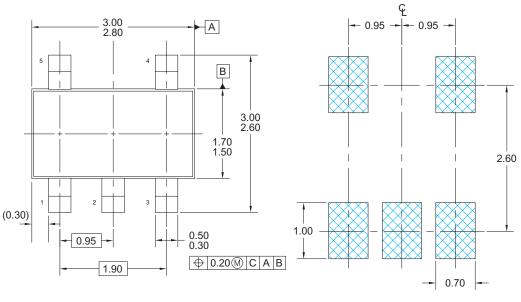


Reel Dimensions inches (millimeters)



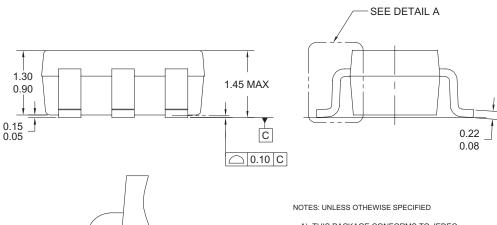
Tape Size	Α	В	С	D	N	W1	W2	W3
8mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/–1.00)

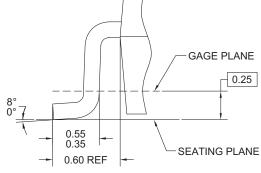
Physical Dimensions



TOP VIEW

LAND PATTERN RECOMMENDATION



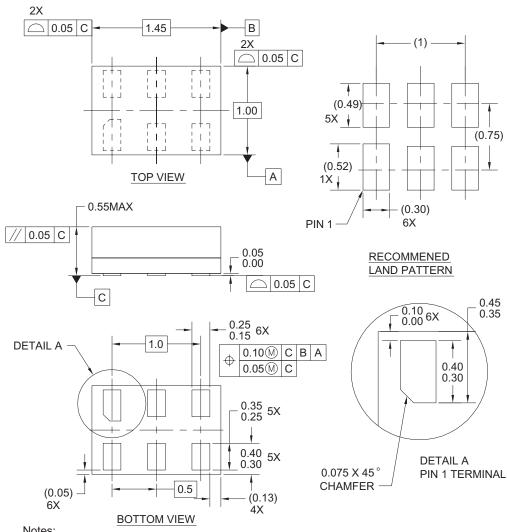


- A) THIS PACKAGE CONFORMS TO JEDEC MO-178, ISSUE B, VARIATION AA, B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) MA05Brev5

Physical Dimensions (Continued) SYMM P 2.00±0.20 — 0.65 0.50 MIN 1.25±0.10 1.90 **3** (0.25)-0.40 MIN -1.30 ⊕ 0.10M A B 0.65 LAND PATTERN RECOMMENDATION 1.30 SEE DETAIL A 1.00 1.10 0.10 0.10 C 2.10 ± 0.30 **SEATING** PLANE GAGE PLANE NOTES: UNLESS OTHERWISE SPECIFIED (R0.10) THIS PACKAGE CONFORMS TO EIAJ SC-88A, 1996. ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. B) C) 0.20 0.46 0.26 DETAIL A SCALE: 60X MAA05AREV5

Figure 5. 5-Lead SC70, EIAJ SC-88a, 1.25mm Wide

Physical Dimensions (Continued)



- Notes:
- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06AREVC

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